# 2SK2933

Silicon N Channel MOS FET High Speed Power Switching

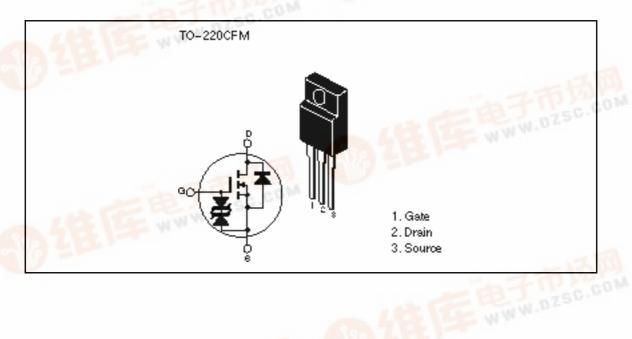
# HITACHI

ADE-208-556 Target Specification 1st. Edition

#### **Features**

- Low on-resistance  $R_{DS} = 0.040$  typ.
- · High speed switching
- 4V gate drive device can be driven from 5V source

#### **Outline**





## 2SK2933

#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	60	V	
Gate to source voltage	V <sub>GSS</sub>	±20	V	
Drain current	I <sub>D</sub>	15	А	
Drain peak current	I <sub>D(pulse)</sub> *1	60	А	
Body to drain diode reverse drain current	I <sub>DR</sub>	15	А	
Avalanche current	I <sub>AP</sub> *3	15	А	
Avalanche energy	E <sub>AR</sub> *3	19	mJ	
Channel dissipation	Pch*2	25	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1. PW 10µs, duty cycle 1 %

2. Value at Tc = 25°C

3. Value at Tch = 25°C, Rg 50

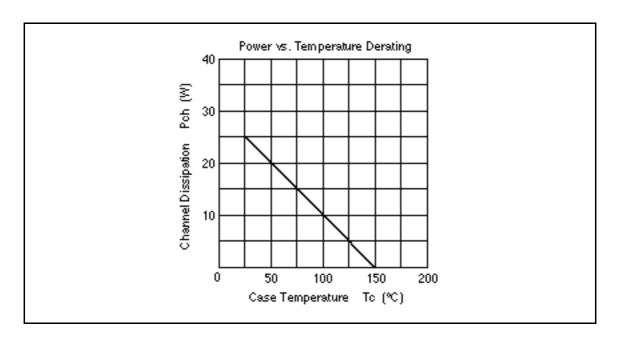
## **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	<b>Test Conditions</b>
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	_	_	V	$I_{D} = 10 \text{mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16V, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	_	10	μΑ	$V_{DS} = 60 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.5	_	2.5	V	$I_{D} = 1 \text{mA}, V_{DS} = 10 \text{V}$
Static drain to source on state	R <sub>DS(on)</sub>	_	0.040	0.052		$I_D = 8A, V_{GS} = 10V^{*1}$
resistance	R <sub>DS(on)</sub>	_	0.060	0.105		$I_D = 8A, V_{GS} = 4V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	10	16	_	S	$I_D = 8A, V_{DS} = 10V^{*1}$
Input capacitance	Ciss	_	500	_	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	260	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	110	_	pF	f = 1MHz
Turn-on delay time	$t_{d(on)}$	_	10	_	ns	$I_D = 8A, V_{GS} = 10V$
Rise time	t <sub>r</sub>	_	80	_	ns	$R_L = 3.75$
Turn-off delay time	$t_{d(off)}$	_	100	_	ns	_
Fall time	t <sub>f</sub>	_	110	_	ns	_
Body to drain diode forward voltage	$V_{DF}$	_	0.9	_	V	$I_F = 15A, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	50	_	ns	$I_F = 15A, V_{GS} = 0$ diF/ dt = 50A/µs

Note: 1. Pulse test

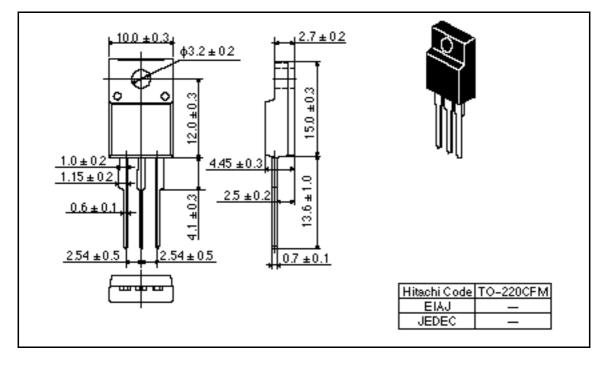
## 2SK2933

#### **Main Characteristics**



#### **Package Dimentions**

Unit: mm



When using this document, keep the following in mind:

- 1. This document may, wholly or partially, be subject to change without notice.
- 2. All rights are reserved: No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without Hitachi's permission.
- 3. Hitachi will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit according to this document.
- 4. Circuitry and other examples described herein are meant merely to indicate the characteristics and performance of Hitachi's semiconductor products. Hitachi assumes no responsibility for any intellectual property claims or other problems that may result from applications based on the examples described herein.
- 5. No license is granted by implication or otherwise under any patents or other rights of any third party or Hitachi, Ltd.
- 6. MEDICAL APPLICATIONS: Hitachi's products are not authorized for use in MEDICAL APPLICATIONS without the written consent of the appropriate officer of Hitachi's sales company. Such use includes, but is not limited to, use in life support systems. Buyers of Hitachi's products are requested to notify the relevant Hitachi sales offices when planning to use the products in MEDICAL APPLICATIONS.

# HITACHI

Hitachi, Ltd.
Semiconductor & IC Div.
Neppon Bidg., 2-6-2, Ohte-medii, Chiyode-ku, Tokyo 100, Japan Tet Tokyo (03, 3270-2111
Fex. (03, 3270-5109)

For further in formellon write to: Histori America, Utd. Semiconductor & IC Dv. 2000 Sierra Point Perlway Briebene, CA. 94005-1835 U.S.A. Tet 445-889-8300

Tet 415-589-8300 Fex 415-583-4207 Hitechi Burope GmbH
Bectronic Components Group
Cartimental Burope
Darnecher Straße 3
D-85622 Feldkirchen
München
Tet 089-9 94 80-0
Fex: 089-9 29 30 00

Hitschi Burope Ltd.
Bedronic Components Div.
Northern Burope Headquarters
Whitebrook Fark
Lower Cook hem Road
Meidenhead
Berkshire SL68YA
Urited Kingdon
Tet 0628-585000
Fex: 0628-778322

Hitschi Asia Pta, Ltd 45 Collyer Quay \$20-00 Hitschi Tower Snappore 0404 Tet 535-2400 Fex: 535-4533

Hitschi Asia (Hong Kong) Ltd.
Unit 705, North Tower,
World Finance Carting
Herbour City, Carton Road
Teim She Teui, Kowloon
Hong Kong
Tot 27359218
Fex: 27306074